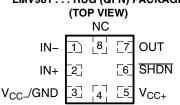
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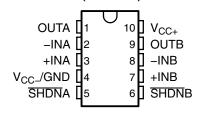
- 1.8-V, 2.7-V, and 5-V Specifications
- Rail-to-Rail Output Swing
 - 600- Ω Load . . . 80 mV From Rail
 - 2-kΩ Load . . . 30 mV From Rail
- V_{ICR} . . . 200 mV Beyond Rails
- Gain Bandwidth . . . 1.4 MHz
- Supply Current . . . 100 μA/Amplifier
- Max V_{IO} . . . 4 mV
- Turn-On Time From Shutdown . . . 8.4 μs
- Space-Saving Packages
 - LMV981: SOT-23-6, SC-70, and QFN
 - LMV982: MSOP and VSSOP
- Applications
 - Industrial (Utility/Energy Metering)
 - Automotive
 - Communications (Optical Telecom, Data/Voice Cable Modems)
 - Consumer Electronics (PDAs, PCs, CDR/W, Portable Audio)
 - Supply-Current Monitoring
 - Battery Monitoring

LMV981 . . . DBV (SOT23-6) OR DCK (SC-70) PACKAGE



NC - No internal connection

LMV982 . . . DGS (VSSOP/MSOP) PACKAGE (TOP VIEW)



description/ordering information

The LMV981 and LMV982 devices are low-voltage, low-power operational amplifiers that are well suited for today's low-voltage and/or portable applications. Specified for operation of 1.8 V to 5 V, they can be used in portable applications that are powered from a single-cell Li-ion or two-cell batteries. They have rail-to-rail input and output capability for maximum signal swings in low-voltage applications. The LMV98x input common-mode voltage extends 200 mV beyond the rails for increased flexibility. The output can swing rail-to-rail unloaded and typically can reach 80 mV from the rails, while driving a $600-\Omega$ load (at 1.8-V operation).

ORDERING INFORMATION†

T _A		PACKAGE [‡]		ORDERABLE PART NUMBER	TOP-SIDE MARKING§
		QFN (RUG)	Reel of 3000	LMV981IRUGR	R7
		00T 00 (DD) ()	Reel of 3000	LMV981IDBVR	RBA_
	Single	SOT-23 (DBV)	Reel of 250	LMV981IDBVT	PREVIEW
-40°C to 125°C		00.70 (DOK)	Reel of 3000	LMV981IDCKR	R7_
		SC-70 (DCK)	Reel of 250	LMV981IDCKT	PREVIEW
	Dural	MCODA/CCOD (DOC)	Reel of 2500	LMV982IDGSR	DOD
	Dual	MSOP/VSSOP (DGS)	Reel of 250	LMV982IDGST	RCB

[†] For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI web site at www.ti.com.

[§] DBV/DCK: The actual top-side marking has one additional character that designates the wafer fab/assembly site.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



[‡] Package drawings, thermal data, and symbolization are available at www.ti.com/packaging.

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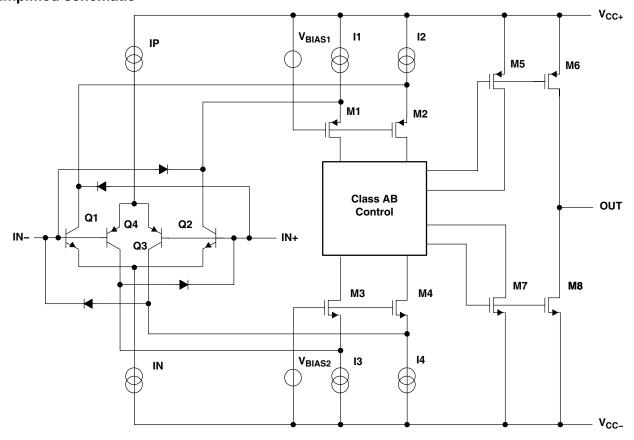
description/ordering information (continued)

The LMV981 and LMV982 devices offer shutdown capability for additional power savings. Pulling the SHDN pin low puts the amplifiers in shutdown, where only 0.156 μ A typically is consumed from a 1.8-V supply. In normal operation with the same 1.8-V supply, the devices typically consume a quiescent current of 103 μ A per channel, and yet they are able to achieve excellent electrical specifications, such as 101-dB open-loop DC gain and 1.4-MHz-gain bandwidth. Furthermore, the amplifiers offer good output drive characteristics, with the ability to drive a 600- Ω load and 1000-pF capacitance, with minimal ringing.

The LMV981 and LMV982 devices are offered in the latest packaging technology to meet the most demanding space-constraint applications. The LMV981 is offered in standard SOT-23 and SC-70 packages. The LMV982 is available in the 10-pin MSOP package.

The LMV98x devices are characterized for operation from –40°C to 125°C, making them universally suited for commercial, industrial, and automotive applications.

simplified schematic





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absolute maximum ratings over free-air temperature range (unless otherwise noted)†

Supply voltage, V _{CC+} – V _{CC-} (see Note 1)		5.5 V
Differential input voltage, V _{ID} (see Note 2)		Supply voltage
Input voltage range, V _I (either input)		$V_{CC-} - 0.2 \text{ V to } V_{CC+} + 0.2 \text{ V}$
Duration of output short circuit (one amplifier) to V _{CC} ± (se	ee Notes 3 and 4)	Unlimited
Package thermal impedance, θ_{JA} (see Notes 4 and 5): Γ	DBV package	
	OCK package	259°C/W
Γ	DGS package	
F	RUG package	253°C/W
Operating virtual junction temperature, T _{.1}		150°C
Storage temperature range, T _{stg}		

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. All voltage values (except differential voltages and V_{CC} specified for the measurement of I_{OS}) are with respect to the network GND.

- 2. Differential voltages are at IN+ with respect to IN-.
- 3. Applies to both single-supply and split-supply operation. Continuous short-circuit operation at elevated ambient temperature can result in exceeding the maximum-allowed junction temperature of 150°C. Output currents in excess of 45 mA over long term may adversely affect reliability.
- 4. Maximum power dissipation is a function of $T_J(max)$, θ_{JA} , and T_A . The maximum allowable power dissipation at any allowable ambient temperature is $P_D = (T_J(max) T_A)/\theta_{JA}$. Operating at the absolute maximum T_J of 150°C can affect reliability.
- 5. The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions

		MIN	MAX	UNIT
V _{CC}	Supply voltage (V _{CC+} – V _{CC-})	1.8	5	V
T _A	Operating free-air temperature	-40	125	°C

ESD protection

TEST CONDITIONS						
Human-Body Model	2000	V				
Machine Model	200	V				

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electrical characteristics at T_A = 25°C, V_{CC+} = 1.8 V, V_{CC-} = 0 V, V_{IC} = $V_{CC+}/2$, V_O = $V_{CC+}/2$, V_C = 0 V, V_{IC} = $V_{CC+}/2$, V_C = V_C (unless otherwise noted)

	PARAMETER		TEST CON	DITIONS	T _A	MIN	TYP	MAX	UNIT		
			11110001 ()	1-1	25°C		1	4			
.,		_	LMV981 (sing	ile)	Full range			6			
V_{IO}	Input offset voltage	9	L MAY (000 (due	.	25°C		1	5.5	mV		
			LMV982 (dual	1)	Full range			7.5			
$\alpha_{V_{IO}}$	Average temperat coefficient of input voltage				25°C		5.5		μV/°C		
	I _{IB} Input bias current		$V_{IC} = V_{CC+} -$	0.8 V	25°C		15	35			
I _{IB}					25°C			65	nA		
					Full range			75			
	I _{IO} Input offset current				25°C		13	25	~ A		
I _{IO}	input oliset current				Full range			40	nA		
					25°C		103	185			
		F						205			
1	Cupply ourrent (no	r channal\		LMV981	25°C		0.156	1			
I _{CC}	Supply current (pe	oply current (per channel) In shutdown		LIVIV961	Full range			2	μΑ		
			III Silutuowii	LM982	25°C		0.178	3.5			
				LIVI902	Full range			5			
			$0 \le V_{IC} \le 0.6$		25°C	60	78				
			1.4 V ≤ V _{IC} ≤ 1.8 V		–40°C to 85°C	55					
CMRR	CMRR Common-mode reject ratio	jection	$0.2 \text{ V} \le \text{V}_{\text{IC}} \le 0.6 \text{ V},$ $1.4 \text{ V} \le \text{V}_{\text{IC}} \le 1.6 \text{ V}$		-40°C to 125°C	55			dB		
			$-0.2 \text{ V} \le V_{IC} \le 0 \text{ V},$ 1.8 V $\le V_{IC} \le 2 \text{ V}$		25°C	50	72				
l.	Supply-voltage rej	ection	1.8 V ≤ V _{CC+} :	≤5 V,	25°C	75	100		٩D		
k _{SVR}	ratio		$V_{IC} = 0.5 \text{ V}$		Full range	70			dB		
					25°C	V _{CC} 0.2	-0.2 to 2.1	$V_{CC+} + 0.2$			
V_{ICR}	Common-mode in range	put voltage	CMRR ≥ 50 d	В	–40°C to 85°C	V _{CC} -		V_{CC+}	V		
	rango				-40°C to 125°C	V _{CC} -+ 0.2		V _{CC+} – 0.2			
			$R_L = 600 \Omega$ to		25°C	77	101				
		LMV981	$V_O = 0.2 \text{ V to}$ $V_{IC} = 0.5 \text{ V}$	1.6 V,	Full range	73					
		LIVIVSOI	$R_L = 2 k\Omega$ to		25°C	80	105				
Δ.,	Large-signal		$V_O = 0.2 \text{ V to} $ $V_{IC} = 0.5 \text{ V}$	1.6 V,	Full range	75			dB		
A_V	voltage gain		$R_L = 600 \Omega$ to		25°C	75	90				
		LMV982	$V_O = 0.2 \text{ V to}$ $V_{IC} = 0.5 \text{ V}$	$V_{O} = 0.2 \text{ V to } 1.6 \text{ V},$		72					
	l l	LIVI V 902	$R_L = 2 \text{ k}\Omega \text{ to } 0.9 \text{ V},$ $V_O = 0.2 \text{ V to } 1.6 \text{ V},$ $V_{IC} = 0.5 \text{ V}$		25°C	78	100				
					Full range	75					



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electrical characteristics at T_A = 25°C, V_{CC+} = 1.8 V, V_{CC-} = 0 V, V_{IC} = $V_{CC+}/2$, V_O = $V_{CC+}/2$, V_C = 1.8 V, V_{CC-} = 0 V, V_{IC} = $V_{CC+}/2$, V_C = $V_{CC+}/2$, V_C = 0 V, V_C = 0

	PARAMETER	TEST CONDITION	NS	T _A	MIN	TYP	MAX	UNIT	
			I Cala Lavari	25°C	1.65	1.72			
		$R_L = 600 \Omega \text{ to } 0.9 \text{ V},$	High level	Full range	1.63				
		$V_{ID} = \pm 100 \text{ mV}$	Low level	25°C		0.077	0.105		
V	Output outing		Low level	Full range			0.12	٧	
V _O	Output swing		High level	25°C	1.75	1.77		V	
		$R_L = 2 k\Omega$ to 0.9 V,	riigirievei	Full range	1.74				
		$V_{ID} = \pm 100 \text{ mV}$	Low level	25°C		0.024	0.035		
			Low level	Full range			0.04		
		$V_O = 0 V$,	Coursing	25°C	4	8			
Ι.	Output	V _{ID} = 100 mV	Sourcing	Full range	3.3			mA	
Ios	short-circuit current	V _O = 1.8 V,	Sinking	25°C	7	9			
<u> </u>		$V_{ID} = -100 \text{ mV}$	Sinking	Full range	5				
T _{on}	Turn-on time from shutdown			25°C		19		μS	
V _{SHDN}	Turn-on voltage to enable part			25°C		1.0		V	
	Turn-off voltage	1				0.55			
GBW	Gain bandwidth product			25°C		1.4		MHz	
SR	Slew rate	See Note 6		25°C		0.35		V/μS	
Φ_{m}	Phase margin			25°C		67		deg	
	Gain margin			25°C		7		dB	
V _n	Equivalent input noise voltage	f = 1 kHz, V _{IC} = 0.5 V		25°C		60		nV/√ Hz	
In	Equivalent input noise current	f = 1 kHz		25°C		0.06		pA/√ Hz	
THD	Total harmonic distortion	$f = 1 \text{ kHz}, A_V = 1, R_L = 600 \text{ s}$ $V_{ID} = 1 \text{ V}_{PP}$	Ω,	25°C		0.023		%	
	Amp-to-amp isolation	See Note 7		25°C		123		dB	

NOTES: 6. Number specified is the slower of the positive and negative slew rates.



^{7.} Input referred, $V_{CC+} = 5$ V and $R_L = 100$ k Ω connected to 2.5 V. Each amp is excited in turn with a 1-kHz signal to produce $V_O = 3$ V_{PP} .

LMV981 SINGLE, LMV982 DUAL 1.8-V OPERATIONAL AMPLIFIERS WITH RAIL-TO-RAIL INPUT AND OUTPUT AND SHUTDOWN

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electrical characteristics at T_A = 25°C, V_{CC+} = 2.7 V, V_{CC-} = 0 V, V_{IC} = $V_{CC+}/2$, V_O = $V_{CC+}/2$, V_C = 0 V, V_{IC} = $V_{CC+}/2$, V_C = V_C (unless otherwise noted)

	PARAMETER		TEST CON	IDITIONS	T _A	MIN	TYP	MAX	UNIT	
					25°C		1	4		
			LMV981 (sing	gle)	Full range			6		
V_{IO}	Input offset voltage	ge			25°C		1	5.5	mV	
			LMV982 (dua	al)	Full range			7.5		
$\alpha_{V_{IO}}$	Average tempera coefficient of inpu voltage				25°C		5.5		μV/°C	
			$V_{IC} = V_{CC+} - 0.8 \text{ V}$		25°C		15	35		
I _{IB}	Input bias current				25°C			65	nA	
-				Full range			75			
					25°C		8	25		
I _{IO}	Input offset curre	nt			Full range			40	nA	
					25°C		105	190		
					Full range			210		
	Supply current (per channel)				25°C		0.61	1	μΑ	
ICC			In shutdown	LMV981	Full range			2		
					25°C		0.101	3.5		
				LM982	Full range			5		
			0 ≤ V _{IC} ≤ 1.5	V,	25°C	60	81			
			$2.3 \text{ V} \le \text{V}_{1\text{C}} \le 2.7 \text{ V}$		-40°C to 85°C	55				
CMRR	Common-mode r ratio	ejection	$0.2 \le V_{IC} \le 1.5 \text{ V},$ $2.3 \text{ V} \le V_{IC} \le 2.5 \text{ V}$		-40°C to 125°C	55			dB	
				$-0.2 \text{ V} \le \text{V}_{\text{IC}} \le 0 \text{ V},$ $2.7 \text{ V} \le \text{V}_{\text{IC}} \le 2.9 \text{ V}$		50	74			
	Supply-voltage re	ejection	1.8 V ≤ V _{CC+}	≤5 V,	25°C	75	100			
k _{SVR}	ratio		$V_{IC} = 0.5 \text{ V}$	•	Full range	70			dB	
					25°C	V _{CC} 0.2	-0.2 to 3.0	V _{CC+} + 0.2		
V_{ICR}	Common-mode i range	nput voltage	CMRR ≥ 50 c	dΒ	-40°C to 85°C	V _{CC} -		V _{CC+}	V	
	range				-40°C to 125°C	V _{CC} _+ 0.2		V _{CC+} – 0.2		
			R _L = 600 Ω t	to 1.35 V,	25°C	87	104			
			$V_0 = 0.2 \text{ V to}$		Full range	86				
		LMV981	$R_L = 2 k\Omega$ to	1.35 V.	25°C	92	110			
	Large-signal		$V_0 = 0.2 \text{ V to}$		Full range	91			45	
A_V	voltage gain		$R_L = 600 \Omega t$	o 1.35 V,	25°C	78	90		dB	
		1.00/000	$V_0 = 0.2 \text{ V to}$		Full range	75				
		LMV982	$R_L = 2 \text{ k}\Omega \text{ to } 1.35 \text{ V},$ $V_O = 0.2 \text{ V to } 2.5 \text{ V}$		25°C	81	100		1	
					Full range	78				



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characteristics at $T_A=25^{\circ}C$, $V_{CC+}=2.7$ V, $V_{CC-}=0$ V, $V_{IC}=V_{CC+}/2$, $V_O=V_{CC+}/2$, $R_L>1$ M Ω , and SHDN tied to V_{CC+} (unless otherwise noted) (continued)

	PARAMETER	TEST CONDITIO	NS	T _A	MIN	TYP	MAX	UNIT
			I Bala I accel	25°C	2.55	2.62		
		$R_L = 600 \Omega \text{ to } 1.35 \text{ V},$	High level	Full range	2.53			
		$V_{ID} = \pm 100 \text{ mV}$	Low level	25°C		0.083	0.11	
\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	Outrost resident		Full range			0.13	V	
Vo	Output swing		High level	25°C	2.65	2.675		V
		$R_L = 2 k\Omega$ to 1.35 V,		Full range	2.64			
		$V_{ID} = \pm 100 \text{ mV}$	Low level	25°C		0.025	0.04	
			Low level	Full range			0.045	
		$V_O = 0 V$,	Coursing	25°C	20	30		
١,	Output short-circuit	V _{ID} = 100 mV	Sourcing	Full range	15			A
los	current	$V_0 = 2.7 \text{ V},$	Circlein a	25°C	18	25		mA
		$V_{ID} = -100 \text{ mV}$	Sinking	Full range	12			
T _{on}	Turn-on time from shutdown			25°C		12.5		μs
V _{SHDN}	Turn-on voltage to enable part			25°C		1.9		٧
• • • • • • • • • • • • • • • • • • • •	Turn-off voltage	1			0.8			
GBW	Gain bandwidth product			25°C		1.4		MHz
SR	Slew rate	See Note 6		25°C		0.4		V/μS
Φ_{m}	Phase margin			25°C		70		deg
	Gain margin			25°C		7.5		dB
V _n	Equivalent input noise voltage	f = 1 kHz, V _{IC} = 0.5 V		25°C		57		nV/√ Hz
In	Equivalent input noise current	f = 1 kHz		25°C		0.082		pA/√ Hz
THD	Total harmonic distortion	$f = 1 \text{ kHz}, \ A_V = 1, \ R_L = 600$ $V_{ID} = 1 \ V_{PP}$	Ω,	25°C		0.022		%
	Amp-to-amp isolation	See Note 7		25°C		123		dB

NOTES: 6. Number specified is the slower of the positive and negative slew rates.



^{7.} Input referred, $V_{CC+} = 5$ V and $R_L = 100$ k Ω connected to 2.5 V. Each amp is excited in turn with a 1-kHz signal to produce $V_O = 3$ V_{PP} .

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electrical characteristics at T_A = 25°C, V_{CC+} = 5 V, V_{CC-} = 0 V, V_{IC} = V_{CC+}/2, V_O = V_{CC+}/2, R_L > 1 M Ω , and SHDN tied to V_{CC+} (unless otherwise noted)

	PARAMETER		TEST CON	DITIONS	T _A	MIN	TYP	MAX	UNIT		
			110/004 / :		25°C		1	4			
.,			LMV981 (sino	gle)	Full range			6			
V_{IO}	Input offset volta	age			25°C		1	5.5	mV		
			LMV982 (dua	al)	Full range			7.5			
$\alpha_{V_{IO}}$	Average temper coefficient of inp voltage				25°C		5.5		μV/°C		
			V _{IC} = V _{CC+} - 0.8 V		25°C		15	35			
I _{IB}	Input bias curre	nt			25°C			65	nA		
					Full range			75			
					25°C		9	25			
I _{IO}	Input offset curr	nput offset current		Full range			40	nA			
					25°C		116	210			
					Full range			230			
					25°C		0.201	1			
Icc	Supply current (per channel)		l	LMV981	Full range			2	μΑ		
			In shutdown		25°C		0.302	3.5			
				LM982	Full range			5			
			$0 \le V_{IC} \le 3.8$	V,	25°C	60	86				
			$4.6 \text{ V} \leq \text{V}_{\text{IC}} \leq 5 \text{ V}$		-40°C to 85°C	55			.		
CMRR	Common-mode ratio	rejection	$0.3 \le V_{IC} \le 3.8 \text{ V},$ $4.6 \text{ V} \le V_{IC} \le 4.7 \text{ V}$		-40°C to 125°C	55			dB		
				$-0.2 \text{ V} \le \text{V}_{\text{IC}} \le 0 \text{ V},$ 5 \text{V} \le \text{V}_{\text{IC}} \le 5.2 \text{V}		50	78				
	Supply-voltage	rejection	1.8 V ≤ V _{CC+}	≤5 V,	25°C	75	100				
k _{SVR}	ratio	·	$V_{IC} = 0.5 \text{ V}$	·	Full range	70			dB		
					25°C	V _{CC} 0.2	-0.2 to 5.3	V _{CC+} + 0.2			
V _{ICR}	Common-mode range	input voltage	CMRR ≥ 50 c	dΒ	-40°C to 85°C	V _{CC} -		V _{CC} +	٧		
	range				-40°C to 125°C	V _{CC} _+ 0.3		V _{CC+} – 0.3			
			R _L = 600 Ω t	to 2.5 V,	25°C	88	102				
			$V_0 = 0.2 \text{ V to}$		Full range	87					
		LMV981	$R_L = 2 k\Omega$ to	2.5 V,	25°C	94	113				
A	Large-signal		$V_0 = 0.2 \text{ V to}$		Full range	93					
A_V	voltage gain		$R_L = 600 \Omega tc$	o 2.5 V,	25°C	81	90		dB		
		LMV982	$V_0 = 0.2 \text{ V to}$		Full range	78					
			$R_L = 2 k\Omega$ to 2.5 V,		25°C	85	100		1		
				$V_0 = 0.2 \text{ V to } 4.8 \text{ V}$		82					



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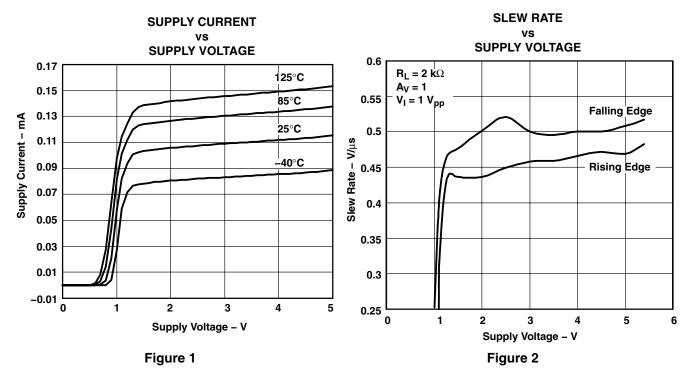
electrical characteristics at T_A = 25°C, V_{CC+} = 5 V, V_{CC-} = 0 V, V_{IC} = V_{CC+} /2, V_O = V_{CC+} /2, V_C = 1 M Ω , and SHDN tied to V_{CC+} (unless otherwise noted) (continued)

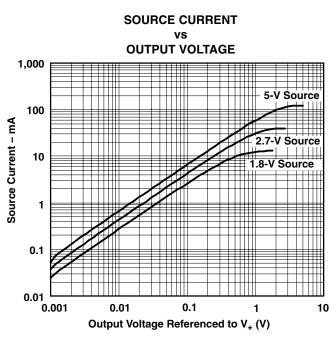
	PARAMETER	TEST CONDITION	NS	T _A	MIN	TYP	MAX	UNIT
			I Cala Issuel	25°C	4.855	4.89		
		$R_L = 600 \Omega \text{ to } 2.5 \text{ V},$	High level	Full range	4.835			
		$V_{ID} = \pm 100 \text{ mV}$	Low level	25°C		0.12	0.16	
\	Output outing		Full range			0.18	v	
Vo	Output swing		High level	25°C	4.945	4.967		V
		$R_L = 2 k\Omega$ to 2.5 V,	r ligit level	Full range	4.935			
		$V_{ID} = \pm 100 \text{ mV}$	Low level	25°C		0.037	0.065	
				Full range			0.075	
		LMV981:	Coursing	25°C	80	100		
١,	Output short-circuit	$V_O = 0 \text{ V}, V_{ID} = 100 \text{ mV}$	Sourcing	Full range	68			4
los	current	V 5 V V 400 mV	Cimbin m	25°C	58	65		mA
		$V_{O} = 5 \text{ V}, V_{ID} = -100 \text{ mV}$	Sinking	Full range	45			
T _{on}	Turn-on time from shutdown			25°C		8.4		μS
V _{SHDN}	Turn-on voltage to enable part			25°C		4.2		V
0.15.1	Turn-off voltage	1			0.8		7	
GBW	Gain bandwidth product			25°C		1.5		MHz
SR	Slew rate	See Note 6		25°C		0.42		V/μS
Φ_{m}	Phase margin			25°C		71		deg
	Gain margin			25°C		8		dB
V _n	Equivalent input noise voltage	f = 1 kHz, V _{IC} = 1 V		25°C		50		nV/√ Hz
In	Equivalent input noise current	f = 1 kHz		25°C		0.07		pA/√ Hz
THD	Total harmonic distortion	$f = 1 \text{ kHz}, A_V = 1, R_L = 600 \text{ s}$ $V_{ID} = 1 \text{ V}_{PP}$	Ω,	25°C		0.022	_	%
	Amp-to-amp isolation	See Note 7		25°C		123		dB

NOTES: 6. Number specified is the slower of the positive and negative slew rates.



^{7.} Input referred, $V_{CC+} = 5$ V and $R_L = 100$ k Ω connected to 2.5 V. Each amp is excited in turn with a 1-kHz signal to produce $V_O = 3$ V_{PP} .





SINK CURRENT VS

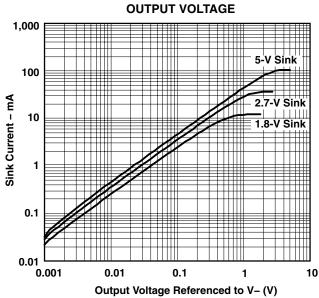
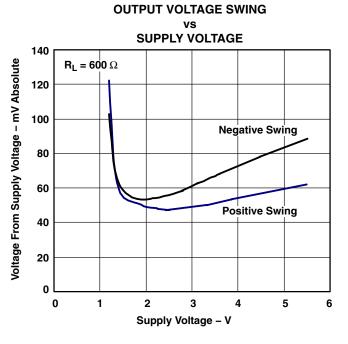


Figure 3 Figure 4

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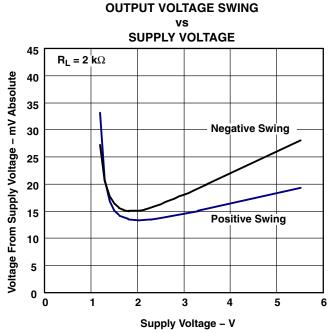
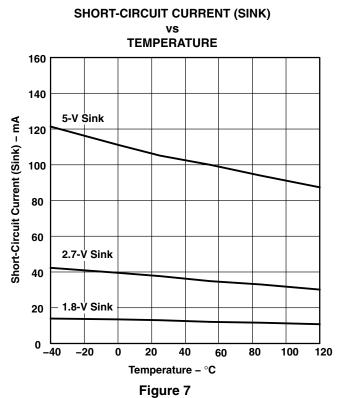
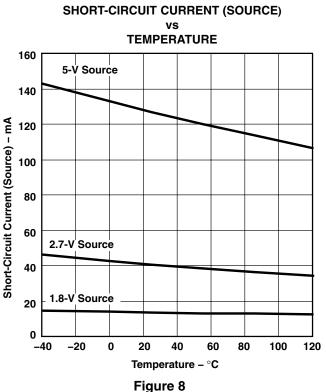


Figure 5







TYPICAL PERFORMANCE CHARACTERISTICS Unless Otherwise Specified, $V_{CC+} = 5 \text{ V}$, Single Supply, $T_A = 25 ^{\circ}\text{C}$

1.8-V FREQUENCY RESPONSE

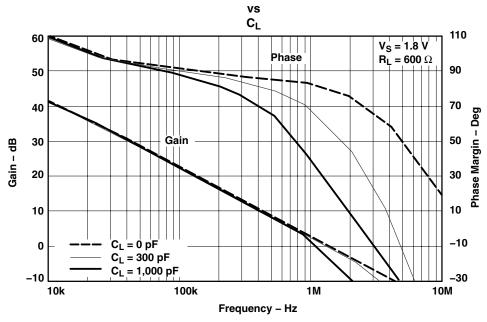


Figure 9

5-V FREQUENCY RESPONSE

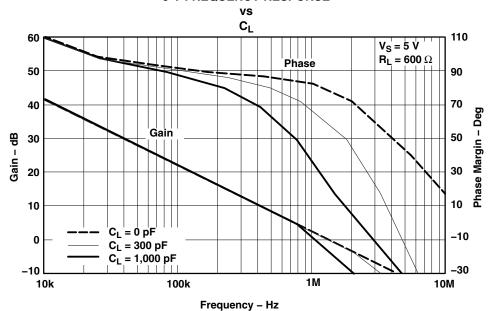


Figure 10



TYPICAL PERFORMANCE CHARACTERISTICS Unless Otherwise Specified, $V_{CC+}=5$ V, Single Supply, $T_A=25^{\circ}C$

1.8-V FREQUENCY RESPONSE

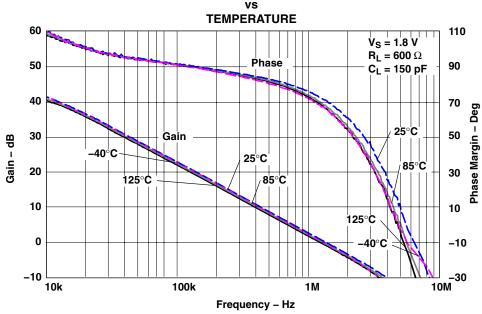


Figure 11

5-V FREQUENCY RESPONSE

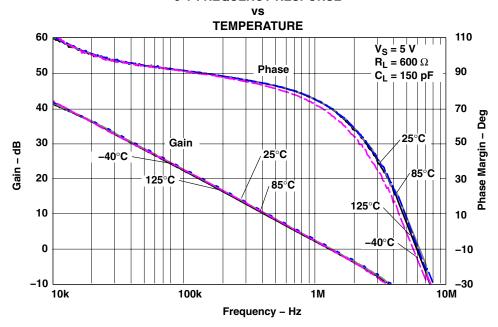
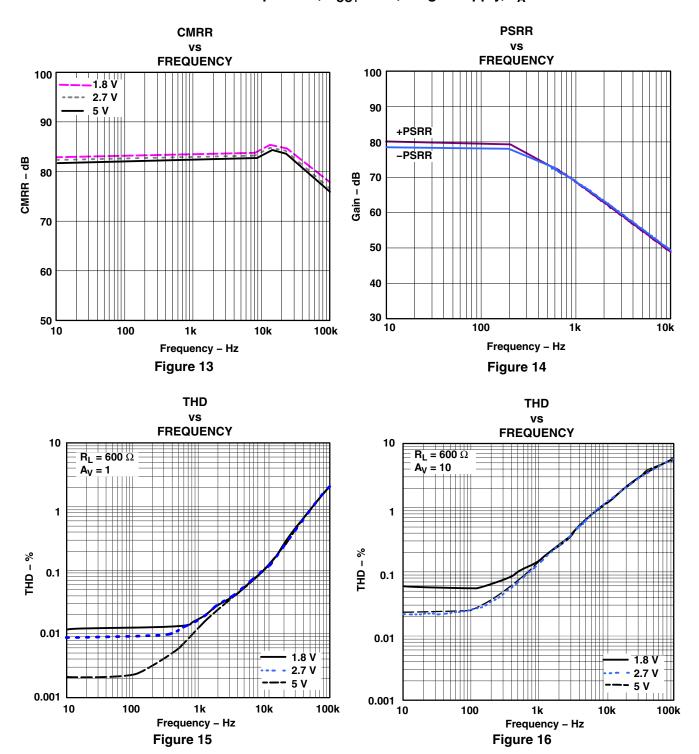
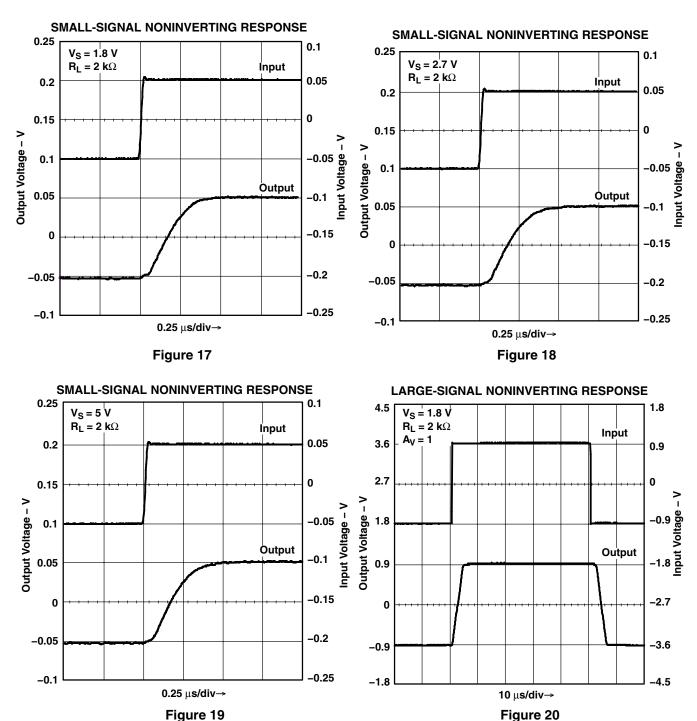


Figure 12

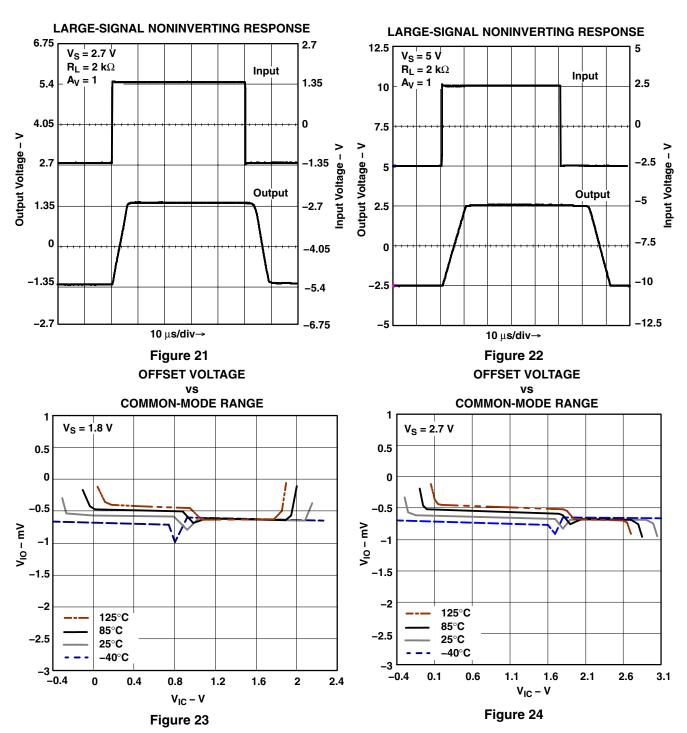




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TYPICAL PERFORMANCE CHARACTERISTICS Unless Otherwise Specified, $V_{CC+}=5$ V, Single Supply, $T_A=25^{\circ}C$

OFFSET VOLTAGE COMMON-MODE RANGE V_S = 5 V 0.5 0 -0.5 V_{IO} - mV -1.5 -2 125°C 85°C -2.5 25°C -40°C -3 -0.4 0.6 1.6 2.6 4.6 5.6 3.6 $V_{IC} - V$ Figure 25





9-Nov-2013

PACKAGING INFORMATION

Orderable Device		Package Type	Package Drawing		Package Qty	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking	Samples
	(1)		Drawing		Qty	(2)	(6)	(3)		(4/5)	
LMV981IDBVR	OBSOLETE	SOT-23	DBV	6		TBD	Call TI	Call TI	-40 to 125	RBA6	
LMV981IDBVRE4	OBSOLETE	SOT-23	DBV	6		TBD	Call TI	Call TI	-40 to 125		
LMV981IDBVRG4	OBSOLETE	SOT-23	DBV	6		TBD	Call TI	Call TI	-40 to 125		
LMV981IDCKR	OBSOLETE	SC70	DCK	6		TBD	Call TI	Call TI	-40 to 125	R76	
LMV981IDCKRE4	OBSOLETE	SC70	DCK	6		TBD	Call TI	Call TI	-40 to 125		
LMV981IDCKRG4	OBSOLETE	SC70	DCK	6		TBD	Call TI	Call TI	-40 to 125		
LMV981IRUGR	OBSOLETE	X2QFN	RUG	8		TBD	Call TI	Call TI	-40 to 125	R7	
LMV981IRUGRG4	OBSOLETE	X2QFN	RUG	8		TBD	Call TI	Call TI	-40 to 125		
LMV982IDGSR	OBSOLETE	VSSOP	DGS	10		TBD	Call TI	Call TI	-40 to 85	RCB	
LMV982IDGSRE4	OBSOLETE	VSSOP	DGS	10		TBD	Call TI	Call TI	-40 to 85		
LMV982IDGSRG4	OBSOLETE	VSSOP	DGS	10		TBD	Call TI	Call TI	-40 to 85		

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes. **Pb-Free** (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.



PACKAGE OPTION ADDENDUM

9-Nov-2013

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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DBV (R-PDSO-G6)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
- D. Leads 1,2,3 may be wider than leads 4,5,6 for package orientation.
- Falls within JEDEC MO-178 Variation AB, except minimum lead width.



DGS (S-PDSO-G10)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion.
- D. Falls within JEDEC MO-187 variation BA.



DCK (R-PDSO-G6)

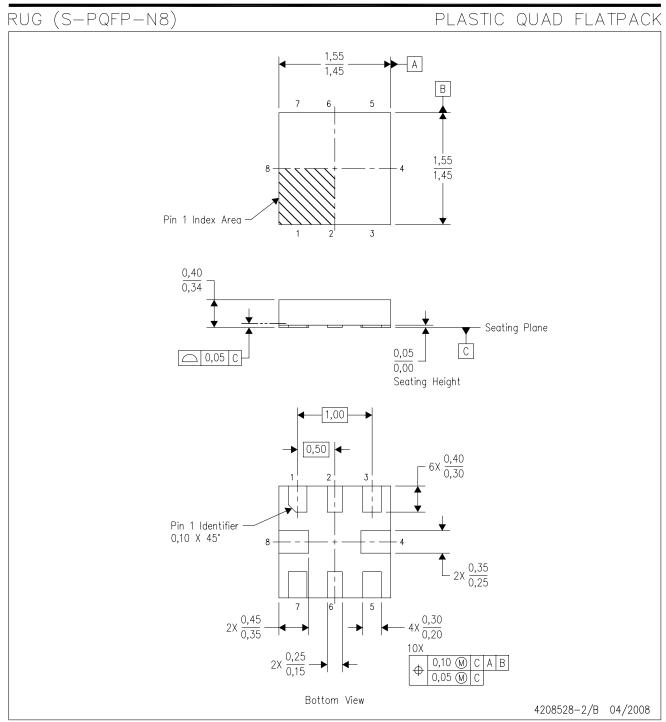
PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
- D. Falls within JEDEC MO-203 variation AB.





NOTES: All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.

- B. This drawing is subject to change without notice.
 C. QFN (Quad Flatpack No-Lead) package configuration.
 D. This package complies to JEDEC MO-288 variation X2ECD.



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